ALMD-CM3F,ALMD-CB3F

High Brightness SMT Round Green & Blue LED Lamps



Data Sheet



Description

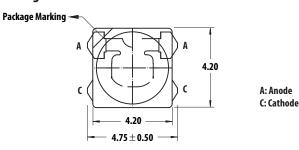
The new Avago ALMD-xx3F LED series has the same or just slightly less luminous intensity than conventional high brightness, through-hole LEDs.

The new LED lamps can be assembled using common SMT assembly processes and are compatible with industrial reflow soldering processes.

The LEDs are made with an advanced optical grade epoxy for superior performance in outdoor sign applications

For easy pick and place assembly, the LEDs are shipped in tape and reel. Every reel is shipped from a single intensity and color bin for better uniformity

Package Dimensions

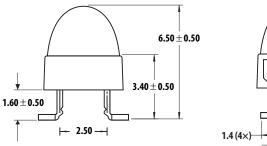


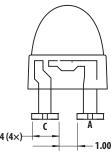
Features

- Compact form factor
- High brightness material
- Available in Green and Blue Color
- Green InGaN 525nm
- Blue InGaN 470nm
- Jedec MSL 2A
- Compatible with reflow soldering process
- Tinted lens
- Typical viewing angle: 30°

Applications

Mono color signs





Notes:

- 1. All dimensions in millimeters (inches).
- 2. Tolerance is \pm 0.20 mm, unless otherwise specified.
- 3. Mildsteel leadframe.

CAUTION: In GaN devices are Class 1C HBM ESD sensitive, AllnGaP devices are Class 1B ESD sensitive per JEDEC Standard. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

CAUTION: Customer is advised to always keep the LED in the MBB with <5% RH when not in use as prolonged exposure to environment might cause the silver-plated leads to tarnish or rust, which might cause difficulties in soldering.

Device Selection Guide

Part Number	Color and Dominant Wavelength	Luminous Inte	ensity Iv (mcd) ^[1,2,5]	Viewing Angle	
	$\lambda_{f d}$ (nm) Typ. $^{{f [3]}}$	Min.	Max.	Typ. (°) ^[4]	
ALMD-CM3F-Y1002	Green 525	9300	21000	30°	
ALMD-CB3F-TV002	Blue 470	2500	5500	30°	

Notes:

- 1. The luminous intensity is measured on the mechanical axis of the lamp package and it is tested with pulsing condition.
- 2. The optical axis is closely aligned with the package mechanical axis.

 3. Dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram and represents the color of the lamp.
- 4. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is half the on-axis intensity.
- 5. Tolerance for each bin limit is \pm 15%.

Part Numbering System



Code	Description	Option	
x1	Package type	C Round InGaN	
x2	Color	B Blue M Green	
х3	Viewing angle	3 30°	
x4	Product specific designation	F	
x5	Minimum intensity bin	Refer to device selection guide	
хб	Maximum intensity bin	Refer to device selection guide	
x7	Color bin selection	0 Full distribution	
x8x9	Packaging option	02 Tested 20mA, 13inch carrier tape	

Absolute Maximum Rating, $T_J = 25$ °C

Parameter	Green	Blue	Unit
DC Forward Current [1]	30	20	mA
Peak Forward Current	100 [2]	100 [2]	mA
Power Dissipation	114	70	mW
LED Junction Temperature	110	105	°C
Operating Temperature Range	-40 to	-40 to +85	
Storage Temperature Range	-40 to	-40 to +100	

Notes:

- 1. Derate linearly as shown in Figure 4.
- 2. Duty Factor 10%, frequency 1 kHz.

Electrical / Optical Characteristics, T_J = 25 °C

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Forward Voltage	V _F				٧	I _F = 20 mA
Green		2.8	3.2	3.8		
Blue		2.8	3.2	3.5		
Reverse Voltage [3]	V _R					
Green & Blue		5			V	$I_R = 10 \mu A$
Dominant Wavelength [1]	λd				nm	I _F = 20 mA
Green		519	525	539		
Blue		460	470	480		
Peak Wavelength						
Green	λ_{PEAK}		522		nm	Peak of Wavelength of Spectral
Blue			464			Distribution at $I_F = 20 \text{ mA}$
Thermal Resistance	Rθ _{J-PIN}				°C/W	LED Junction-to-Pin
Green			270			
Blue			480			
Luminous Efficacy [2]						
Green	η_V		500		lm/W	Emitted Luminous Power/Emitted
Blue			85			Radiant Power
Thermal coefficient of λ_d		<u> </u>			nm/°C	$I_F = 20 \text{ mA}; +25^{\circ}\text{C} \le T_J \le +100^{\circ}\text{C}$
Green			0.033			
Blue			0.033			

Notes:

- 1. The dominant wavelength is derived from the chromaticity diagram and represents the color of the lamp.
- 2. The radiant intensity, l_e in watts per steradian, may be found from the equation $l_e = l_V/\eta_V$ where l_V is the luminous intensity in candelas and η_V is the luminous efficacy in lumens/watt.
- 3. Indicates product final testing condition. Long-term reverse bias is not recommended.

InGaN

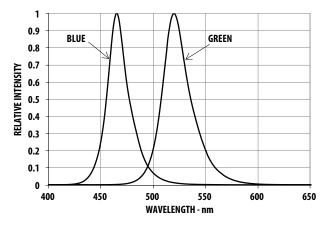


Figure 1. Relative Intensity vs Wavelength



Figure 3. Relative Intensity vs Forward Current

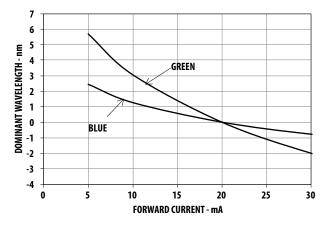


Figure 5. Dominant Wavelength Shift vs Forward Current

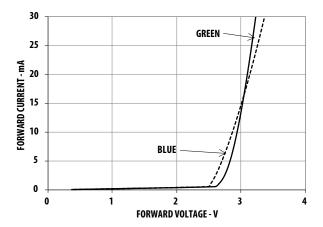


Figure 2. Forward Current vs Forward Voltage

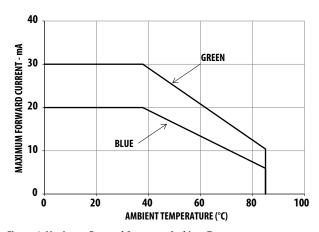


Figure 4. Maximum Forward Current vs Ambient Temperature

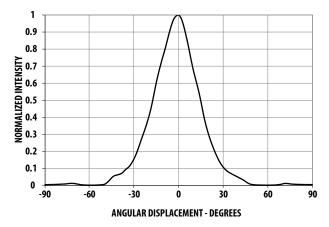


Figure 6a. Radiation Pattern for X axis

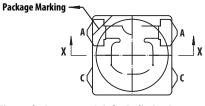


Figure 6b. Component Axis for Radiation Pattern

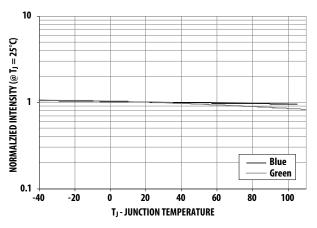


Figure 7. Relative Intensity Shift vs Junction Temperature

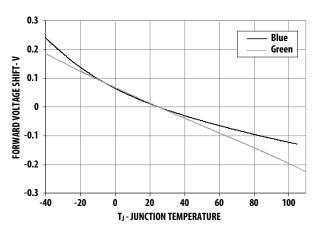


Figure 8. Forward Voltage Shift vs Junction Temperature

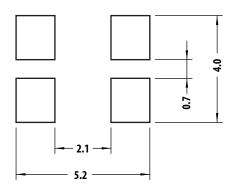


Figure 9. Recommended Soldering Land Pattern

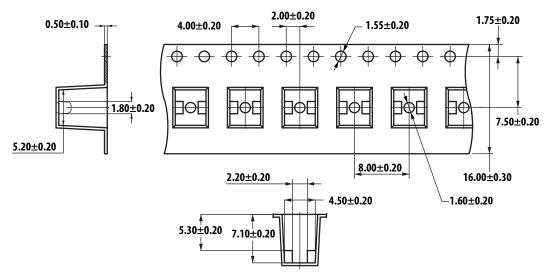


Figure 10. Carrier Tape Dimension

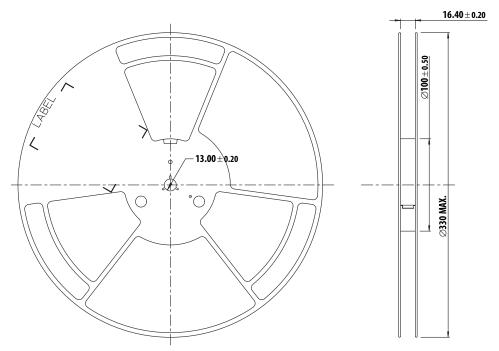


Figure 11. Reel Dimension

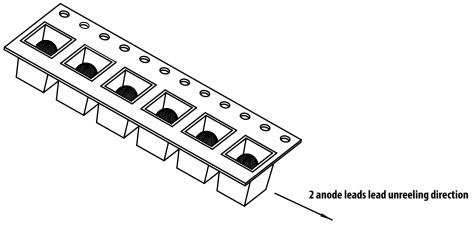


Figure 12. Unit Orientation from reel

Intensity Bin Limit Table (1.3:1 lv bin ratio)

	Intensity (mcd) at 20 mA					
Bin	Min.	Max.				
Т	2500	3200				
U	3200	4200				
V	4200	5500				
W	5500	7200				
Χ	7200	9300				
Υ	9300	12000				
Z	12000	16000				
1	16000	21000				

Tolerance for each bin limit is \pm 15%

Blue Color Range

	Min	Max				
Bin	Dom	Dom	Xmin	Ymin	Xmax	Ymax
1	460.0	464.0	0.1440	0.0297	0.1766	0.0966
			0.1818	0.0904	0.1374	0.0374
2	464.0	468.0	0.1374	0.0374	0.1699	0.1062
			0.1766	0.0966	0.1291	0.0495
3	468.0	472.0	0.1291	0.0495	0.1616	0.1209
			0.1699	0.1062	0.1187	0.0671
4	472.0	476.0	0.1187	0.0671	0.1517	0.1423
			0.1616	0.1209	0.1063	0.0945
5	476.0	480.0	0.1063	0.0945	0.1397	0.1728
			0.1517	0.1423	0.0913	0.1327

Tolerance for each bin limit is ± 0.5 nm

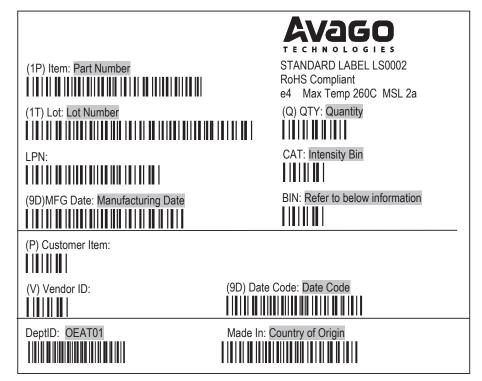
Green Color Range

Bin	Min Dom	Max Dom	Xmin	Ymin	Xmax	Ymax
1	519.0	523.0	0.0667	0.8323	0.1450	0.7319
			0.1200	0.7375	0.0979	0.8316
2	523.0	527.0	0.0979	0.8316	0.1711	0.7218
			0.1450	0.7319	0.1305	0.8189
3	527.0	531.0	0.1305	0.8189	0.1967	0.7077
			0.1711	0.7218	0.1625	0.8012
4	531.0	535.0	0.1625	0.8012	0.2210	0.6920
			0.1967	0.7077	0.1929	0.7816
5	535.0	539.0	0.1929	0.7816	0.2445	0.6747
			0.2210	0.6920	0.2233	0.7600

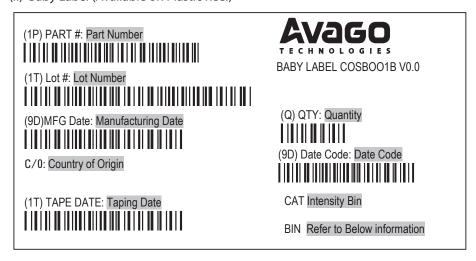
Tolerance for each bin limit is ± 0.5 nm

Packing Label

(i) Mother Label (Available on MBB bag)



(ii) Baby Label (Available on Plastic Reel)



Note: Acronyms and Definition:

BIN:

(i) Color bin only or V_F bin only

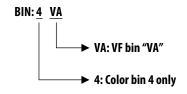
(Applicable for part number with color bins but without V_F bin or part number with V_F bins and no color bin)

(ii) Color bin incorporated with V_F bin

Applicable for part number that have both color bin and V_{F} bin

Example:

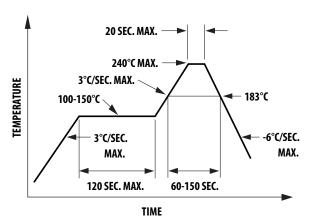
- a. Color bin only or V_F bin only
 BIN: 4 (represent color bin 4 only)
 BIN: V_A (represent V_F bin "V_A" only)
- b. Color bin incorporate with V_F bin



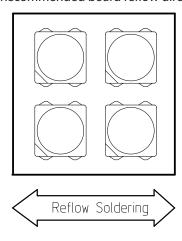
Soldering

Recommended reflow soldering condition:

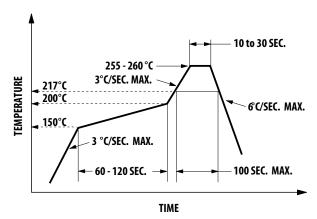
(i) Leaded reflow soldering:



- Reflow soldering must not be done more than two times. Do observe necessary precautions for handling a moisture-sensitive device, as stated in the following section.
- b. Recommended board reflow direction:



(ii) Lead-free reflow soldering:

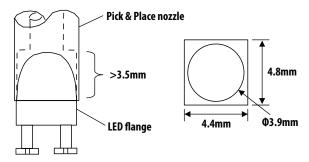


- c. Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- d. It is preferred that you use reflow soldering to solder the LED. Use hand soldering only for rework if unavoidable but must be strictly controlled to the following conditions:
 - Soldering iron tip temperature = 320 °C max.
 - Soldering duration = 3 sec max.
 - Number of cycles = 1 only
 - Power of soldering iron = 50 W max.
- e. Do not touch the LED body with a hot soldering iron except the soldering terminals as this may damage the LED.
- f. For de-soldering, it is recommended to use appropriate double head soldering iron. User is advised to confirm beforehand whether the functionality and performance of the LED is affected by hand soldering.

PRECAUTIONARY NOTES

1. Handling precautions

For automated pick and place, Avago has tested nozzle size below made with urethane material to be working fine with this LED. However, due to the possibility of variations in other parameters such as pick and place machine maker/model and other settings of the machine, customer is recommended to verify the nozzle selected.



Note

- 1. Nozzle tip should touch the LED flange during pick and place.
- 2. Outer dimensions of the nozzle should be able to fit into the carrier tape pocket.

2. Handling of moisture-sensitive device

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Avago Application Note AN5305, Handling of Moisture Sensitive Surface Mount Devices, for additional details and a review of proper handling procedures.

a. Before use

- An unopened moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity Indicator Card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is recommended that the MBB not be opened prior to assembly (e.g. for IQC).

b. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <30°C / 60%RH at all times and all high temperature related processes including soldering, curing or rework need to be completed within 672 hours.

c. Control for unfinished reel

- Unused LEDs must be stored in a sealed MBB with desiccant or desiccator at <5%RH.

d. Control of assembled boards

 If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure that all LEDs have not exceeded their floor life of 672 hours.

e. Baking is required if:

- The HIC indicator is not BROWN at 10% and is AZURE at 5%.
- The LEDs are exposed to condition of >30°C / 60% RH at any time.
- The LED floor life exceeded 672hrs.
 The recommended baking condition is: 60±5°C for 20hrs. Baking should only be done once.

f. Storage

The soldering terminals of these Avago LEDs are silver plated. If the LEDs are being exposed in ambient environment for too long, the silver plating might be oxidized and thus affecting its solderability performance. As such, unused LEDs must be kept in sealed MBB with desiccant or in desiccator at <5%RH.</p>

3. Application precautions

- a. Drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the datasheet. Constant current driving is recommended to ensure consistent performance.
- b. LED is not intended for reverse bias. Do use other appropriate components for such purpose. When driving the LED in matrix form, it is crucial to ensure that the reverse bias voltage is not exceeding the allowable limit of the LED.
- c. Avoid rapid change in ambient temperature especially in high humidity environment as this will cause condensation on the LED.
- d. If the LED is intended to be used in outdoor or harsh environment, the LED leads must be protected with suitable potting material against damages caused by rain water, oil, corrosive gases etc. It is recommended to have louver or shade to reduce direct sunlight on the LEDs.

4. Eye safety precautions

LEDs may pose optical hazards when in operation. It is not advisable to view directly at operating LEDs as it may be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipments.

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